

GaAs INTEGRATED CIRCUIT μ PG2405T6Q

1 W SP3T SWITCH

DESCRIPTION

The μ PG2405T6Q is an SP3T GaAs FET switch which was developed for BluetoothTM, wireless LAN and NFC.

This device can operate frequency from 500 MHz to 2.5 GHz, having the low insertion loss and high linearity.

This device is housed in a 10-pin plastic TSSON (Thin Shrink Small Out-line Non-leaded) package. And this package is able to high-density surface mounting.

FEATURES

Lins = 0.45 dB TYP. @ f = 1.0 GHz, Vcont (H) = 2.8 V, Vcont (L) = 0 V
 Lins = 0.55 dB TYP. @ f = 2.0 GHz, Vcont (H) = 2.8 V, Vcont (L) = 0 V
 Lins = 0.60 dB TYP. @ f = 2.5 GHz, Vcont (H) = 2.8 V, Vcont (L) = 0 V
 High isolation
 ISL = 28 dB TYP. @ f = 1.0 GHz, Vcont (H) = 2.8 V, Vcont (L) = 0 V
 ISL = 22 dB TYP. @ f = 2.0 GHz, Vcont (H) = 2.8 V, Vcont (L) = 0 V
 ISL = 20 dB TYP. @ f = 2.5 GHz, Vcont (H) = 2.8 V, Vcont (L) = 0 V
 Handling power
 Pin (0.1 dB) = +31.0 dBm TYP. @ f = 2.5 GHz, Vcont (H) = 2.8 V, Vcont (L) = 0 V

• High-density surface mounting : 10-pin plastic TSSON package ($2.0 \times 1.35 \times 0.37$ mm)

APPLICATIONS

- Bluetooth and IEEE802.11b/g etc.
- NFC (FeliCa[™] etc.)

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2405T6Q-E2	μPG2405T6Q-E2-A	10-pin plastic TSSON (Pb-Free)	G5M	Embossed tape 8 mm wide Pin 5, 6 face the perforation side of the tape Qty 3 kpcs/reel

Remark To order evaluation samples, please contact your nearby sales office.

Part number for sample order: μ PG2405T6Q

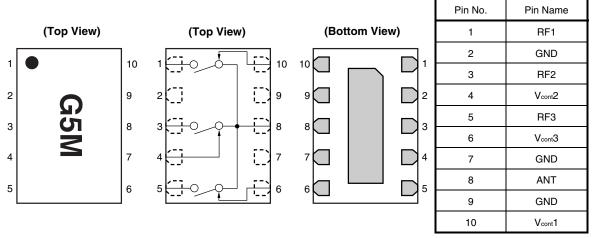
Caution Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

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PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Remark Exposed pad : GND

TRUTH TABLE

V _{cont} 1	V _{cont} 2	V _{cont} 3	ANT-RF1	ANT-RF2	ANT-RF3
High	Low	Low	ON	OFF	OFF
Low	High	Low	OFF	ON	OFF
Low	Low	High	OFF	OFF	ON

ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	Vcont	+6.0 Note	V
Input Power	Pin	+34	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	Tstg	-55 to +150	°C

Note $|V_{cont (H)} - V_{cont (L)}| \le 6.0 \text{ V}$

RECOMMENDED OPERATING RANGE (TA = +25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	V _{cont (H)}	2.7	2.8	3.0	٧
Switch Control Voltage (L)	V _{cont (L)}	-0.2	0	0.2	٧
Control Voltage Difference (H)	△V _{cont (H)} Note1	-0.1	0	0.1	V
Control Voltage Difference (L)	△V cont (L) Note2	-0.1	0	0.1	V

Notes 1. $\triangle V_{cont}$ (H) is a difference between the maximum and the minimum control voltages among $V_{cont}1$ (H), $V_{cont}2$ (H) and $V_{cont}3$ (H).

2. ΔV_{cont} (L) is a difference between the maximum and the minimum control voltages among V_{cont} 1 (L), V_{cont} 2 (L) and V_{cont} 3 (L).

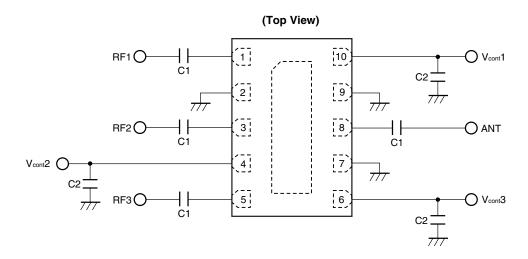
ELECTRICAL CHARACTERISTICS

(TA = +25°C, V_{cont} (H) = 2.8 V, V_{cont} (L) = 0 V, Z_O = 50 Ω , DC blocking capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Pass	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins	ANT to RF1, 2, 3	f = 0.5 to 1.0 GHz	-	0.45	0.65	dB
			f = 1.0 to 2.0 GHz	-	0.55	0.80	dB
			f = 2.0 to 2.5 GHz	-	0.60	0.85	dB
Isolation	ISL	ANT to RF1, 2, 3	f = 0.5 to 1.0 GHz	24	28	ı	dB
		(OFF)	f = 1.0 to 2.0 GHz	18	22	I	dB
			f = 2.0 to 2.5 GHz	16	20	1	dB
Input Return Loss	RLin	ANT to RF1, 2, 3	f = 0.5 to 2.5 GHz	15	20	-	dB
Output Return Loss	RLout	ANT to RF1, 2, 3	f = 0.5 to 2.5 GHz	15	20	ı	dB
0.1 dB Loss Compression Input Power ^{Note}	Pin (0.1 dB)	ANT to RF1, 2, 3	f = 2.5 GHz	+29.0	+31.0	-	dBm
2nd Harmonics	2f0	ANT to RF1, 2, 3	f = 2.5 GHz, P _{in} = 23 dBm	65	75	-	dBc
3rd Harmonics	3f0	ANT to RF1, 2, 3	f = 2.5 GHz, P _{in} = 23 dBm	65	75	-	dBc
Switch Control Current	Icont		RF None	ı	0.2	50	μΑ
Switch Control Speed	tsw			-	700	ı	ns

Note Pin (0.1 dB) is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

EVALUATION CIRCUIT

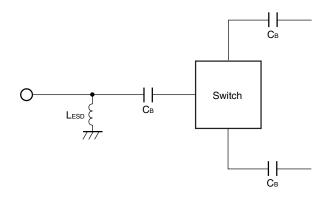


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

USING THE NEC EVALUATION BOARD

Symbol	Values	
C1	56 pF	
C2	1 000 pF	

APPLICATION INFORMATION

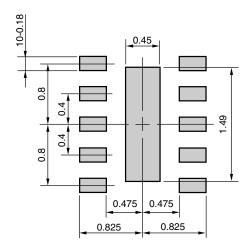


- \bullet $C_{\mbox{\scriptsize B}}$ are DC blocking capacitors external to the device.
- A value of 56 pF is sufficient for operation from 500 MHz to 2.5 GHz bands.
- The value may be tailored to provide specific electrical responses.
- The RF ground connections should be kept as short as possible and connected to directly to a good RF ground for best performance.
- Lesp provides a means to increase the ESD protection on a specific RF port, typically the port attached to the antenna.

MOUNTING PAD LAYOUT DIMENSIONS

10-PIN PLASTIC TSSON (UNIT: mm)

MOUNTING PAD

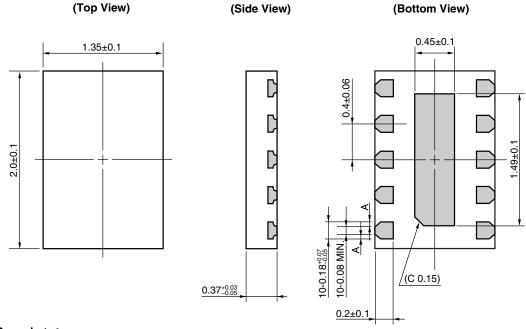


Remark The mounting pad layout in this document is for reference only.

When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder bridge and so on, in order to optimize the design.

PACKAGE DIMENSIONS

10-PIN PLASTIC TSSON (UNIT: mm)



Remark A>0

(): Reference value

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

NEC μ PG2405T6Q

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GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.